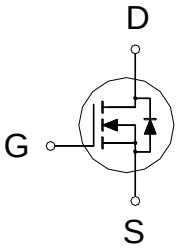
**NIKO-SEM**

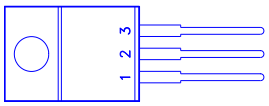
# N-Channel Enhancement Mode Field Effect Transistor

**PP2H06AT**
**TO-220**
**Halogen-Free & Lead-Free**

## PRODUCT SUMMARY

| $V_{(BR)DSS}$ | $R_{DS(ON)}$ | $I_D$ |
|---|---|---|
| 60V | 3.2mΩ | 147A |




1. GATE
2. DRAIN
3. SOURCE

## ABSOLUTE MAXIMUM RATINGS ($T_A$ = 25 °C Unless Otherwise Noted)

| PARAMETERS/TEST CONDITIONS | | SYMBOL | LIMITS | UNITS |
|---|---|---|---|---|
| Drain-Source Voltage | | $V_{DS}$ | 60 | V |
| Gate-Source Voltage | | $V_{GS}$ | ±20 | V |
| Continuous Drain Current | $T_C$ = 25 °C | $I_D$ | 147 | A |
| | $T_C$ = 100 °C | | 104 | |
| Pulsed Drain Current[1] | | $I_{DM}$ | 200 | |
| Avalanche Current | | $I_{AS}$ | 57 | |
| Avalanche Energy | L = 0.1mH | $E_{AS}$ | 162 | mJ |
| Power Dissipation | $T_C$ = 25 °C | $P_D$ | 136 | W |
| | $T_C$ = 100 °C | | 68 | |
| Operating Junction & Storage Temperature Range | | $T_j$, $T_{stg}$ | -55 to 175 | °C |

## THERMAL RESISTANCE RATINGS

| THERMAL RESISTANCE | SYMBOL | TYPICAL | MAXIMUM | UNITS |
|---|---|---|---|---|
| Junction-to-Case | $R_{\theta JC}$ | | 1.1 | °C / W |
| Junction-to- Ambient[2] | $R_{\theta JA}$ | | 62.5 | |

[1]Pulse width limited by maximum junction temperature.

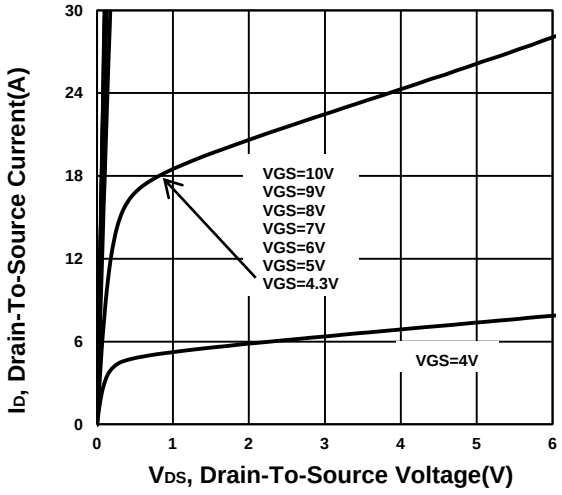
## ELECTRICAL CHARACTERISTICS ($T_J$ = 25 °C, Unless Otherwise Noted)

| PARAMETER | SYMBOL | TEST CONDITIONS | LIMITS | | | UNIT |
|---|---|---|---|---|---|---|
| | | | MIN | TYP | MAX | |
| **STATIC** | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ | $V_{GS}$ = 0V, $I_D$ = 250μA | 60 | | | V |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}$ = $V_{GS}$, $I_D$ = 250μA | 2 | 2.9 | 4 | |
| Gate-Body Leakage | $I_{GSS}$ | $V_{DS}$ = 0V, $V_{GS}$ = ±20V | | | ±100 | nA |
| Zero Gate Voltage Drain Current | $I_{DSS}$ | $V_{DS}$ =60V, $V_{GS}$ = 0V | | | 1 | μA |
| | | $V_{DS}$ = 60V, $V_{GS}$ = 0V, $T_J$ = 55 °C | | | 10 | |
| Drain-Source On-State Resistance[1] | $R_{DS(ON)}$ | $V_{GS}$ = 10V, $I_D$ = 20A | | 2.6 | 3.2 | mΩ |

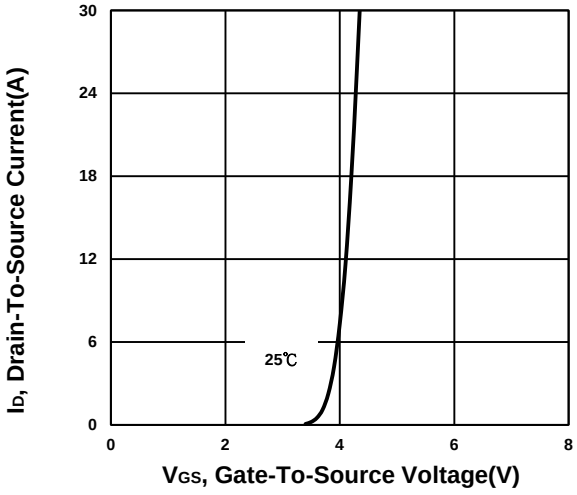
| | | | | | | |
|---|---|---|---|---|---|---|
| Forward Transconductance[1] | $g_{fs}$ | $V_{DS}$ = 5V, $I_D$ = 20A | | 79 | | S |
| **DYNAMIC** | | | | | | |
| Input Capacitance | $C_{iss}$ | $V_{GS}$ = 0V, $V_{DS}$ = 30V, f = 1MHz | | 3600 | | pF |
| Output Capacitance | $C_{oss}$ | | | 969 | | |
| Reverse Transfer Capacitance | $C_{rss}$ | | | 27 | | |
| Gate Resistance | $R_g$ | $V_{GS}$ = 0V, $V_{DS}$ = 0V, f = 1MHz | | 0.8 | | Ω |
| Total Gate Charge[2] | $Q_g$ | $V_{DS}$ = 30V , $V_{GS}$ = 10V, $I_D$ = 20A | | 62 | | nC |
| Gate-Source Charge[2] | $Q_{gs}$ | | | 15 | | |
| Gate-Drain Charge[2] | $Q_{gd}$ | | | 18 | | |
| Turn-On Delay Time[2] | $t_{d(on)}$ | $V_{DS}$ = 30V , $I_D \cong$ 20A, $V_{GS}$ = 10V, $R_{GEN}$ =6Ω | | 22 | | nS |
| Rise Time[2] | $t_r$ | | | 58 | | |
| Turn-Off Delay Time[2] | $t_{d(off)}$ | | | 57 | | |
| Fall Time[2] | $t_f$ | | | 62 | | |
| **SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ($T_J$ = 25 °C)** | | | | | | |
| Continuous Current | $I_S$ | | | | 113 | A |
| Forward Voltage[1] | $V_{SD}$ | $I_F$ = 20A, $V_{GS}$ = 0V | | | 1.2 | V |
| Reverse Recovery Time | $t_{rr}$ | $I_F$ = 20A, $dI_F/dt$ = 100A / μS | | 47 | | nS |
| Reverse Recovery Charge | $Q_{rr}$ | | | 50 | | nC |

[1]Pulse test : Pulse Width ≤ 300 μsec, Duty Cycle ≤ 2%.
[2]Independent of operating temperature.

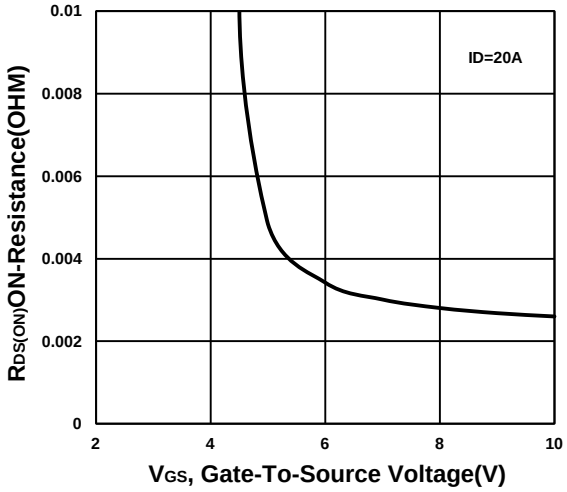
## Output Characteristics



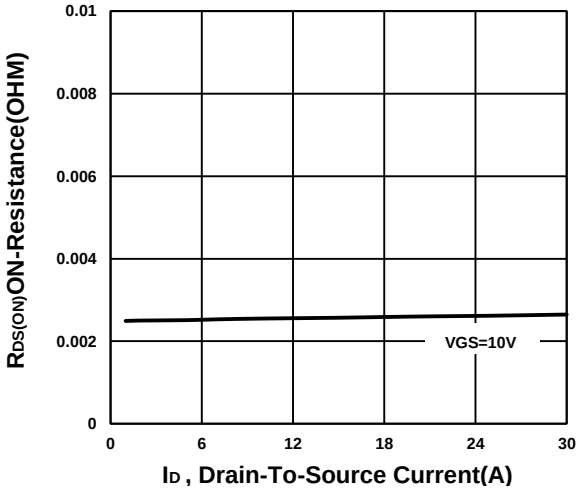

## Transfer Characteristics



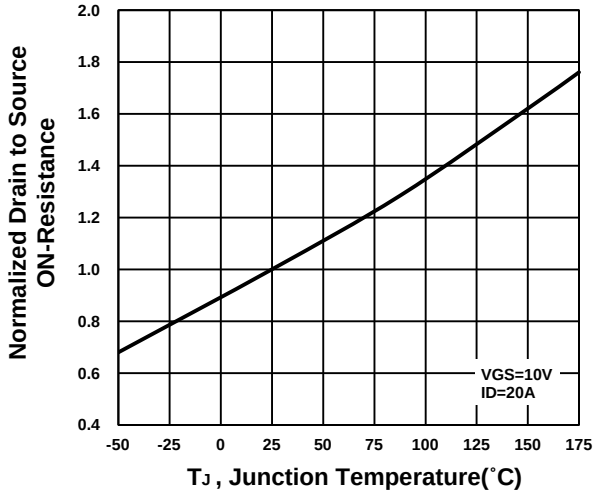

## On-Resistance VS Gate-To-Source Voltage



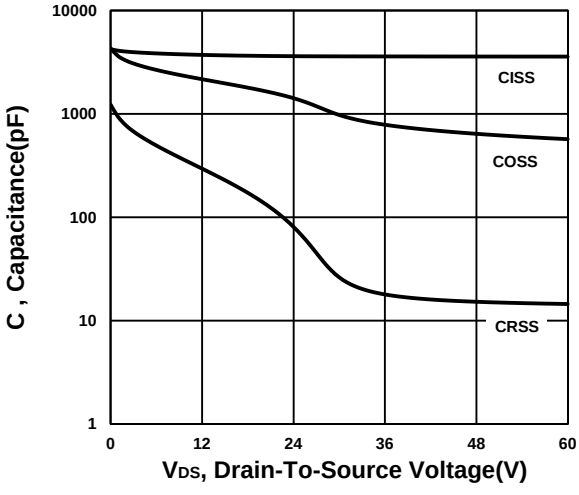

## On-Resistance VS Drain Current



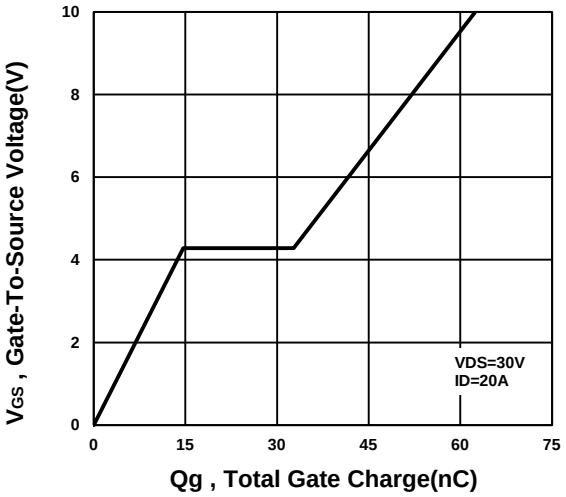

## On-Resistance VS Temperature



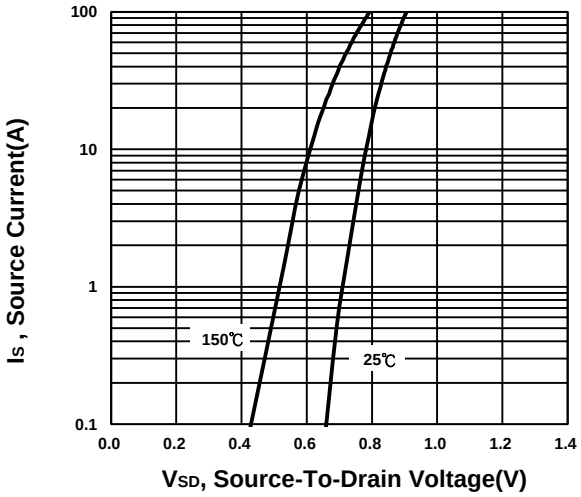

## Capacitance Characteristic



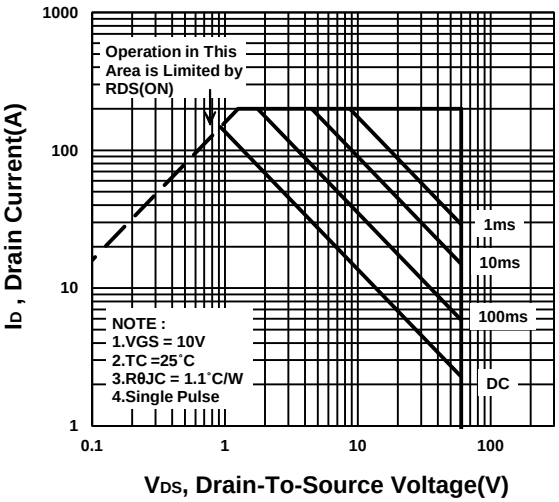
## Gate charge Characteristics



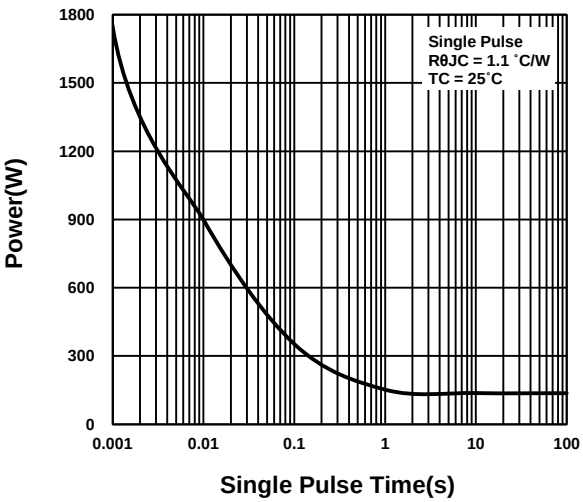

## Source-Drain Diode Forward Voltage




## Safe Operating Area




## Single Pulse Maximum Power Dissipation




## Transient Thermal Response Curve